KP-1608YC

YELLOW

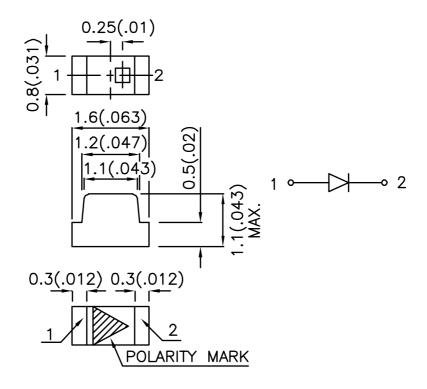
#### **Features**

- •1.6mmX0.8mm SMT LED, 1.1mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS / REEL .
- •Rohs Compliant.

#### **Description**

The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

#### **Package Dimensions**



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

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#### **Selection Guide**

Part No.	Dice	Iv (mcd) Lens Type @ 20mA		,	Viewing Angle
		,.	Min.	Тур.	201/2
KP-1608YC	YELLOW (GaAsP/GaP)	WATER CLEAR	2.6	8	120°

#### Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Yellow	590		nm	IF=20mA
λD	Dominant Wavelength	Yellow	588		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Yellow	35		nm	IF=20mA
С	Capacitance	Yellow	20		pF	VF=0V;f=1MHz
VF	Forward Voltage	Yellow	2.1	2.5	V	IF=20mA
lR	Reverse Current	Yellow		10	uA	VR = 5V

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Yellow	Units
Power dissipation	105	mW
DC Forward Current	30	mA
Peak Forward Current [1]	140	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

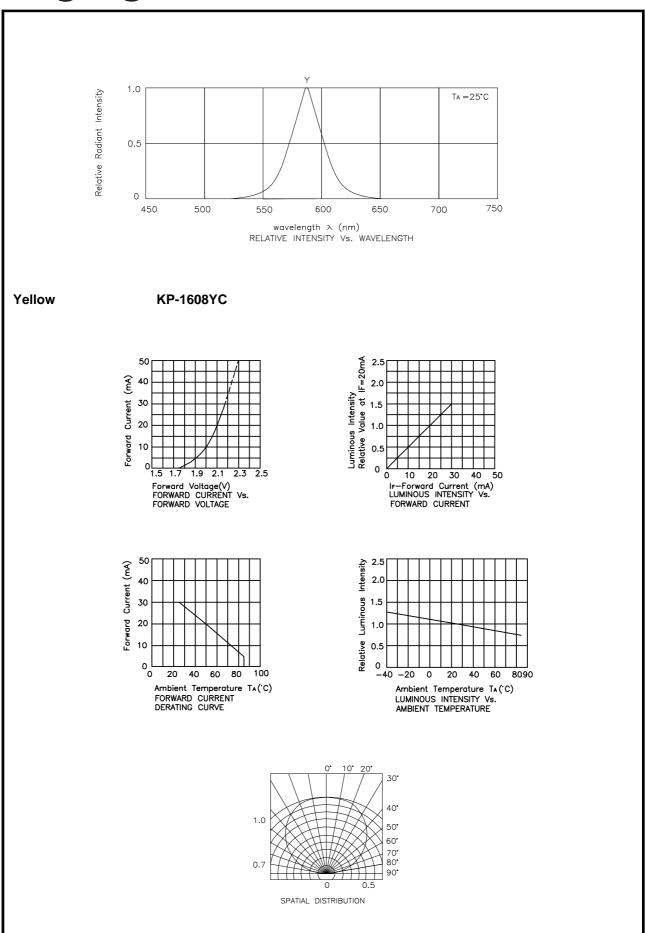
Note:

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Note: 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

<sup>1. 1/10</sup> Duty Cycle, 0.1ms Pulse Width.

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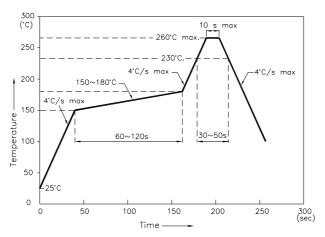


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#### **KP-1608YC**

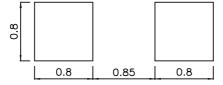
Reflow Soldering Profile For Lead-free SMT Process.



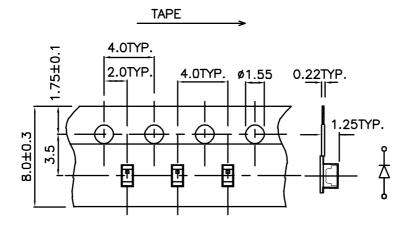
NOTES:

- 1.We recommend the reflow temperature  $245^{\circ}\text{C}(+/-5^{\circ}\text{C})$ .The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

### Recommended Soldering Pattern (Units: mm)



### Tape Specifications (Units: mm)



If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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